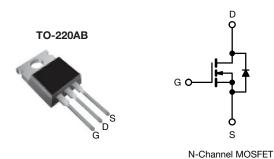


Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	100	
$R_{DS(on)}\left(\Omega\right)$	$V_{GS} = 5.0 \text{ V}$	0.27
Q _g (Max.) (nC)	12	
Q _{gs} (nC)	3.0	
Q _{gd} (nC)	7.1	
Configuration	Single	Э

FEATURES

- · Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 175 °C operating temperature
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL520PbF
Lead (Pb)-free and halogen-free	IRL520PbF-BE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	100	V	
Gate-source voltage			V_{GS}	± 10	\ \ \	
Continuous drain current	V _{GS} at 5 V	T _C = 25 °C	,	9.2		
Continuous drain current	V _{GS} at 5 V	T _C = 100 °C	I _D	6.5	Α	
Pulsed drain current ^a			I _{DM}	36		
Linear derating factor			0.40	W/°C		
Single pulse avalanche energy b			E _{AS}	170	mJ	
Repetitive avalanche current a			I _{AR}	9.2	А	
Repetitive avalanche energy ^a			E _{AR}	6.0	mJ	
Maximum power dissipation	T _C =	25 °C	P _D	60	W	
Peak diode recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^d	For 10 s			300 d	°C	
Mauring towns	6.00.04	MO corour		10	lbf ⋅ in	
Mounting torque	6-32 or M3 screw			1.1	N · m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 9.2 A (see fig. 12)
- c. $I_{SD} \le 9.2 \text{ A}$, $dI/dt \le 110 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \,^{\circ}\text{C}$
- d. 1.6 mm from case



Vishay Siliconix

THERMAL RESISTANCE RAT	INGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	
Case-to-sink, flat, greased surface	R _{thCS}	0.50	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	2.5	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static						l	<u> </u>
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 10 V	-	-	± 100	nA
		V _{DS} = 100 V, V _{GS} = 0 V		-	-	25	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 80 V	V _{GS} = 0 V, T _J = 150 °C	-	-	250	μA
Drain-source on-state resistance	Б	V _{GS} = 5.0 V	I _D = 5.5 A ^b	-	-	0.27	Ω
	$R_{DS(on)}$	V _{GS} = 4.0 V	I _D = 4.6 A ^b	-	-	0.38	
Forward transconductance	g _{fs}	V _{DS} :	= 50 V, I _D = 5.5 A	3.2	-	-	S
Dynamic						•	
Input capacitance	C _{iss}		$V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V},$		490	-	pF
Output capacitance	C _{oss}]			150	-	
Reverse transfer capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	30	-	1
Total gate charge	Qg			-	-	12	
Gate-source charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b	-	-	3.0	nC
Gate-drain charge	Q_{gd}]	goo ng. o ana ro	-	-	7.1	
Turn-on delay time	t _{d(on)}			-	9.8	-	
Rise time	t _r	V_{DD} = 50 V, I_{D} = 9.2 A, R_{g} = 9.0 Ω , R_{D} = 5.2 Ω , see fig. 10 ^b		-	64	-	ns
Turn-off delay time	t _{d(off)}			-	21	-	
Fall time	t _f]		-	27	-	1
Internal drain inductance	L _D	6 mm (0.25") 1	Between lead, 6 mm (0.25") from		4.5	-	nH
Internal source inductance	L _S	package and center of die contact		-	7.5	-	ווח
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	Is	MOSFET sym showing the	MOSFET symbol showing the		-	9.2	А
Pulsed diode forward current ^a	I _{SM}	integral reverse p - n junction diode		-	-	36	
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 9.2 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body diode reverse recovery time	t _{rr}	T 25 °C 1	- 0.2 A dl/dt = 100 A/web	-	130	190	ns
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 9.2 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^b$		-	0.83	1.0	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and $L_{\overline{L}}$				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

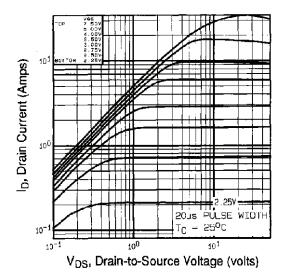


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

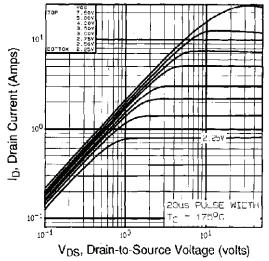


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

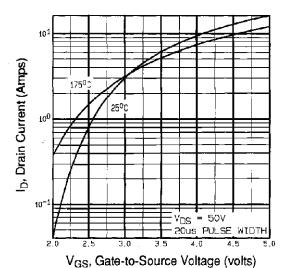


Fig. 3 - Typical Transfer Characteristics

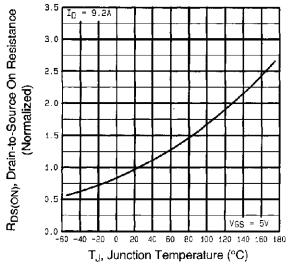


Fig. 4 - Normalized On-Resistance vs. Temperature



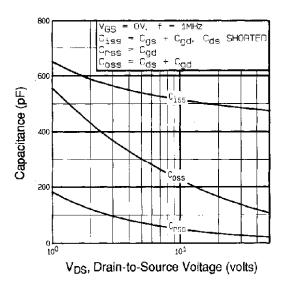


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

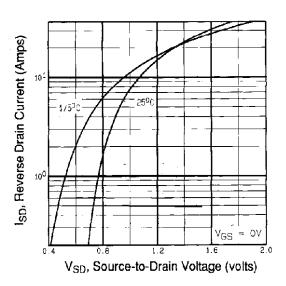


Fig. 7 - Typical Source-Drain Diode Forward Voltage

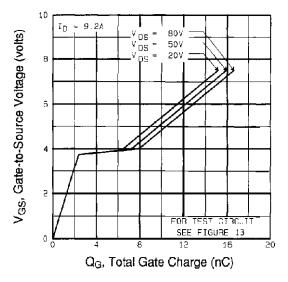


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

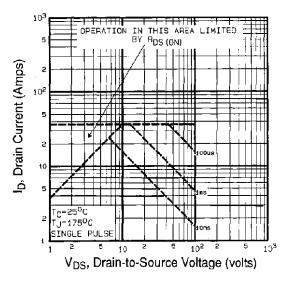


Fig. 8 - Maximum Safe Operating Area



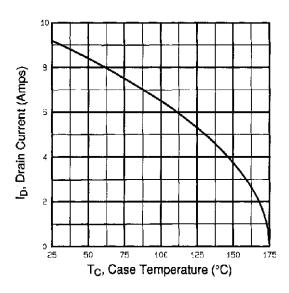


Fig. 9 - Maximum Safe Operating Area

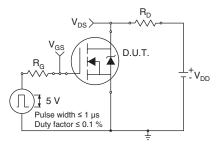


Fig. 10a - Switching Time Test Circuit

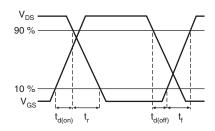


Fig. 10b - Switching Time Waveforms

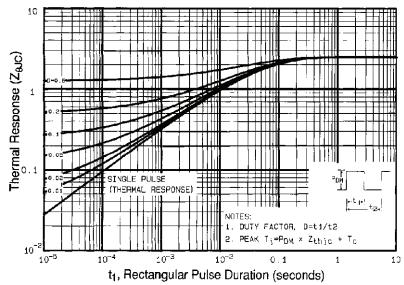
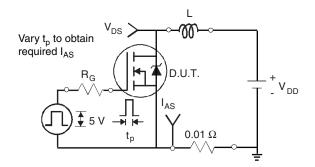


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case







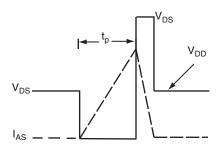


Fig. 12b - Unclamped Inductive Waveforms

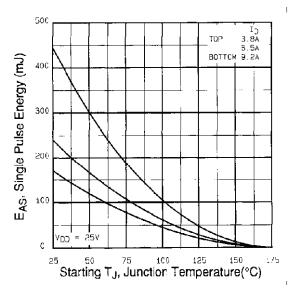


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

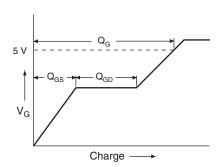


Fig. 13a - Basic Gate Charge Waveform

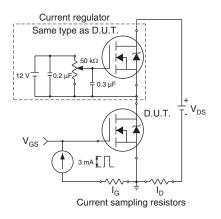
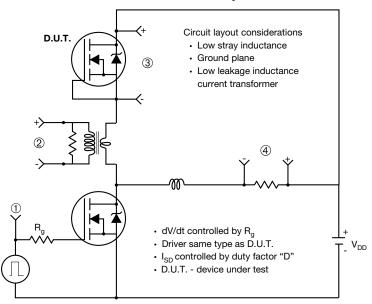


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



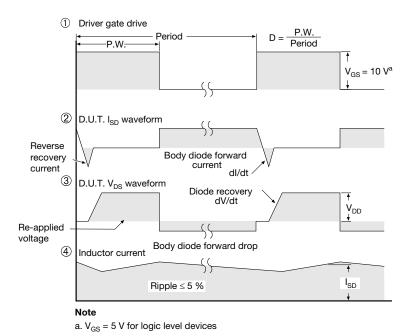


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIM	IETERS	INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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